

L Number	Hits	Search Text	DB	Time stamp
12	2	4821152.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/10/07 09:59
95	8714	winding with copper	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/10/07 11:40
96	1715	winding near copper	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/10/07 11:40
97	1715	winding near copper and py@<1980	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/10/07 11:42
98	182	winding near copper and @py<1980	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/10/07 11:43
99	11	winding near copper and @py<1980 and 361/\$	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/10/07 11:45
100	3	winding near copper same bifilar and @py<1980	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/10/07 11:46
101	20	winding near copper adj wire and @py<1980	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/10/07 11:47
102	1	winding near copper adj wire same limiter	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/10/07 11:48
103	2	winding near copper adj wire same limiting	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/10/07 11:49
104	413	winding near copper adj wire	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/10/07 11:49
105	1	winding near copper adj wire same bifilar	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/10/07 11:49
106	4	winding near2 copper adj wire same bifilar	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/10/07 11:51

107	354	winding near2 copper adj wire with coil	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/07 11:51
108	3	winding near2 copper adj wire with coil same bifilar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/07 11:51
109	3	winding near2 copper adj wire with coil and bifilar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/07 11:51
110	45	copper adj wire with coil and bifilar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/07 11:58
113	34	copper adj wire with coil and bifilar	USPAT	2004/10/07 11:59
116	1	aluminum same copper adj wire with coil and bifilar	USPAT	2004/10/07 12:00
117	203	aluminum same copper adj wire with coil	USPAT	2004/10/07 12:00
118	85	aluminum same copper adj wire with coil and @py<1990	USPAT	2004/10/07 12:04
119	1	aluminum same copper adj wire with coil and bifilar	USPAT	2004/10/07 12:04
120	34	copper adj wire with coil and bifilar	USPAT	2004/10/07 12:05
-	2	"20040047105"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 10:31
- - -	-1	inrush same current same bifilar same winding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 14:45
-	1	inrush same bifilar same winding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 14:45
-	22	protection same bifilar same winding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 11:43
-	265	inductance same bifilar same winding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 11:44
-	144	inductance with bifilar with winding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 11:44
-	4	inductance with bifilar with winding with resistance	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 11:48

	0	inductance with bifilar with winding with inrush	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 11:47
	0	bifilar with winding with inrush	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 11:47
	70	bifilar with winding with resistance	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 11:48
	0	bifilar with winding with resistance same inrush	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 11:48
	612	resistance same inrush	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 11:48
	256	resistance same inrush same limit\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 11:50
	49	resistance same inrush same limit\$3 same AC	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 11:51
	22	resistance with inrush same limit\$3 same AC	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 11:56
	5	("4328459" "4504898" "4678984" "5619127" "5715154").PN.	USPAT	2004/09/29 11:53
	20	resistance with inrush with limit\$3 same AC	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 12:55
	0	20030102947.URPN.	USPAT	2004/09/29 11:59
	2	6166619.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 12:35
	2	5973584.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 12:40
	1	de-20119996-\$ did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 12:40
	345	resistance same mounting same soldering same board	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:16

	89	resistance with mounting with soldering with board	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:16
	3	resistance with mounting with soldering with board with pin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:18
	13	resistance with mounting with soldering with pin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:19
	354	resistance with mounting with pin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:20
	20	resistance with mounting with pin same solder\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:24
	138	wire with mounting with pin same solder\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:28
	0	bifilar with winding same mounting with pin same solder\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:28
	1	bifilar with winding same mounting with pin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:31
	1	bifilar with winding same (solder soldering) with pin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:32
	0	resistor adj wire same (solder soldering) with pin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:32
	0	resistor\$3 adj wire same (solder soldering) with pin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:33
	985	resistor\$3 adj wire	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:33
	30	resistor\$3 adj wire same (mounting mount)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:33
	1	resistor\$3 adj wire same (mounting mount) same pin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:34

	589	resistor\$3 same (mounting mount) same pin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:34
	464	resistor same (mounting mount) same pin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:34
	112	resistor with (mounting mount) with pin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 13:34
	13	inrush with protection with induct\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 15:12
	228	(inrush transient) with protection with induct\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 15:13
	4	(inrush transient) with protection with induct\$5 and bifilar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 15:48
	413	induct\$5 with bifilar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/29 15:48
	167	induct\$5 with bifilar near winding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 09:54
	1	de-20119996-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 09:55
	1	2002-373299	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 10:32
	6	("5118363" "3851290" "1641115") .pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 10:33
	6	("6118363" "3851290" "1641115") .pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 10:36
	7	("6118363" "3851290" "4641115") .pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 10:39
	4	(4,057,774 3,573,676) .pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 11:36

	125	inrush same inductance	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 11:37
	27	inrush same inductance same transient	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 12:46
	542	inrush with power adj supply	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 12:48
	0	inrush with power adj supply with inductance	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 12:49
	6	inrush with power adj supply same inductance	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 13:08
	114	(electromagnetic adj compatibility) same induct\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 13:42
	16	(electromagnetic adj compatibility) same induct\$5	EPO; DERWENT	2004/09/30 13:26
	10	(electromagnetic adj compatibility) same low near induct\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 14:21
	81	(crosstalk cross-talk emc) same (inductor inductance) near low	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 14:57
	8	(crosstalk cross-talk emc) same (inductor inductance) near low	EPO; JPO; DERWENT	2004/09/30 14:24
	3	(crosstalk cross-talk emc) same (inductor inductance) near (power near (supply source))	EPO; JPO; DERWENT	2004/09/30 14:45
	1	(crosstalk cross-talk emc) same (inductor inductance) near (power near (supply source)) and 6483714.pn.	USPAT; EPO; JPO; DERWENT	2004/09/30 14:42
	6	6483714.pn.	USPAT; EPO; JPO; DERWENT	2004/09/30 14:43
	10	(crosstalk cross-talk emc) same (inductor inductance) near (power near (supply source))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/30 14:50
	8	(crosstalk cross-talk emc) same (inductor inductance) near2 power adj supply	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/30 14:58
	509	coil with winding with insulated adj wire	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:00

-	0	coil with winding with insulated adj wire with copper	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:01
-	18	coil with winding with insulated adj wire with copper	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:05
-	149785	coil with winding wire with copper	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:05
-	1330	coil with winding with wire with copper	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:05
-	10	coil with winding with wire with copper same bifilar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:12
-	0	coil with winding with wire with copper same bifilar same space	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:13
-	0	coil with winding with wire with copper same bifilar same spaced	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:13
-	3	coil with winding with wire with copper same insulation same spaced	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:21
-	103	coil with winding with wire with copper near insulat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:21
-	123	coil with winding with wire near copper near insulat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:22
-	119	coil with winding with copper adj wire near insulat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:23
-	38	coil near winding with copper adj wire near insulat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:24
-	7641	coil near winding with copper adj wire near insulat\$3 adn bifilar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:24
-	0	coil near winding with copper adj wire near insulat\$3 and bifilar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:25

	0	coil near winding with copper with wire near insulat\$3 and bifilar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:25
	1	coil near winding with copper with wire with insulat\$3 and bifilar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:26
	0	coil near winding with copper with wire with insulat\$3 same bifilar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 14:26
	11	winding with copper with wire with insulat\$3 same bifilar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 15:32
	14013	winding with spaced	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 15:32
	.0	winding with spaced with wire with apart	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 15:33
	411	winding with spaced with wire with apart	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 15:33
	140	coil with winding with spaced with wire with apart	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 15:34
	2	coil with winding with spaced with wire with apart with insulation	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 15:35
	4	winding with spaced with wire with apart with insulation	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 15:36
	40	winding with spaced with wire with insulation	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 15:38
	12	winding with spaced with wire with bare	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 15:40
	25	coil with spaced with wire with bare	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/01 15:40
	55	integrated adj circuit with pin near soldered	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/04 16:38

	1	integrated adj circuit with terminal adj pin near soldered	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/04 16:39
	55	integrated adj circuit with pin near soldered	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/04 16:45
	649	circuit with (wire adj end pin) near soldered	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/04 16:46
	0	circuit with (wire adj end pin) near soldered with printed near circuit adj board	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/04 16:47
	0	(wire adj end pin) near soldered with printed near circuit adj board	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/04 16:47
	0	(wire pin) near soldered with printed near circuit adj board	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/04 16:47
	446	(wire pin) near soldered with printed near circuit adj board	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/04 16:47
	281	circuit with (wire adj end pin) near soldered with printed near circuit adj board	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/04 16:48
	5	circuit with (wire adj end terminal adj pin) near soldered with printed near circuit adj board	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/04 16:50
	0	circuit with (terminal adj pin) near soldered with printed near circuit adj board	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/04 16:50
	27	circuit with (terminal adj pin) near soldered with printed near circuit adj board	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/07 09:58
	2	circuit with (terminal adj pin) near soldered with printed near circuit adj board with wire	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/04 16:55